

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







1 Ω R_{ON} SPST Switch

The NLAS5113 is an SPST switch designed for very low R_{ON} applications within portable devices. The NLAS5113 operates over a wide V_{CC} range, 1.65 V to 4.5 V, and maintain a very low R_{ON} : 1.3 Ω Max @ V_{CC} = 4.2 V. It is available in a choice of two packages: SC88 and UDFN6.

Features

- R_{ON} : 1.3 Ω Max @ V_{CC} = 4.2 V
- V_{CC} Range: 1.65 V to 4.5 V
- UDFN6 or SC88 Packages Available
- These are Pb-Free Devices

Typical Applications

- Mobile Phones
- Portable Devices



ON Semiconductor®

http://onsemi.com

MARKING DIAGRAMS



UDFN6 CASE 517AA





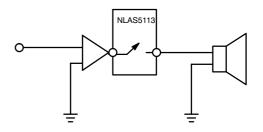
SC-88 CASE 419B



XX = Device CodeM = Date CodePb-Free Package

(Note: Microdot may be in either location)

APPLICATION DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
NLAS5113MUTBG	UDFN6 (Pb-Free)	3000/Tape & Reel
NLAS5113DFT2G	SC-88 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

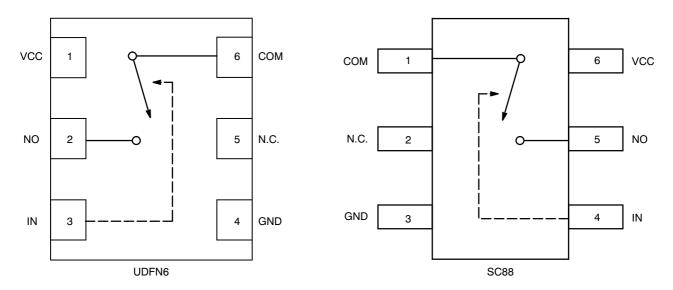


Figure 1. Functional Block Diagram Pinouts

Pin #	Name	Direction	Description
1	V _{CC}	Input	Analog Supply Voltage
2	NO	I/O	Normally Open Signal Line
3	IN	Input	Control Input for Switch #
4	GND	Input	Ground
5	N.C.	N/A	No Connect
6	COM	I/O	Common Signal Line

FUNCTION TABLE

IN	NO
0	OFF
1	ON

OPERATING CONDITIONS

MAXIMUM RATINGS

Symbol	Pins	Parameter	Value	Condition	Unit
V _{CC}	V _{CC}	Positive DC Supply Voltage	-0.5 to 5.5		V
V_{IS}	NOx, NCx, COMx	Analog Signal Voltage	-0.5 to V _{CC} + 0.5		V
V _{IN}	IN1, IN2	IN2 Control Input Voltage -0.5 to 6.0			V
I _{CC}	V _{CC}	Positive DC Supply Current	50		mA
lis_con	NOx, NCx, COMx	Analog Signal Continuous Current	±300	Closed Switch	mA
l _{IS_PK}	PK NOx, NCx, COMx Analog Signal Peak Current		±500	10% Duty Cycle	mA
I _{IN}	IN	Control Input Current			mA
T _{STG}		Storage Temperature Range	-65 to 150		°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Pins	Parameter	Value	Condition	Unit
V _{CC}	V _{CC}	Positive DC Supply Voltage	1.65 to 4.5		V
V _{IS}	NOx, NCx, COMx	Analog Signal Voltage	0 to V _{CC}		V
V _{IN}	IN1, IN2	Control Input Voltage	0 to V _{CC}		V
T _A		Operating Temperature Range	-40 to 85		°C

NOTE: Minimum and maximum values are guaranteed through test or design across the **Recommended Operating Conditions**, where applicable. Typical values are listed for guidance only and are based on the particular conditions listed for each section, where applicable. These conditions are valid for all values found in the characteristics tables unless otherwise specified in the test conditions.

		Test Conditions		Min	Тур	Max	Unit
20μΑ							
INx	Control Input High	2.7 V < V _{CC}		2.0			V
INx	Control Input Low					0.8	٧
		•			-	=	-
INx	Control Input Leakage	0 V < V _{IN} < V _{CC}			±0.1	±1.0	μА
NCx, NOx	OFF State Leakage	0 V < V _{COM} , V _{NO} < V _{CC}	0 V < V _{COM} , V _{NO} < V _{CC}			±1.0	μΑ
COMx	ON State Leakage	0 V < V _{COM} , V _{NO} < V _{CC}			±0.5	±2.0	μΑ
V _{CC}	Quiescent Supply	All Channels ON or OFF; V _{IN} = V _{CC} or GND, I _{OUT} = 0;		1.0	2.0	μΑ	
I _{ON} = -100 m	$IA, V_{IS} = 0 \text{ to } V_{CC}$						
Pins	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Unit
	ON Resistance		2.7 4.2		1.7 1.1	2.0 1.3	Ω
	R _{ON} Flatness		2.7 4.2		0.4 0.4		Ω
	INx INx NCx, NOx COMx Vcc	INx Control Input Leakage NCx, NOx OFF State Leakage COMx ON State Leakage V _{CC} Quiescent Supply Flon = -100 mA, V _{IS} = 0 to V _{CC} Pins Parameter ON Resistance	INx Control Input Leakage 0 V < V _{IN} < V _{CC} NCx, NOx OFF State Leakage 0 V < V _{COM} , V _{NO} < V _{CC} COMx ON State Leakage 0 V < V _{COM} , V _{NO} < V _{CC} V _{CC} Quiescent Supply All Channels ON or OFF; V _{IN} = V _{CC} or GND, I _{OUT} = 0; I _{ON} = -100 mA, V _{IS} = 0 to V _{CC} Pins Parameter Test Conditions	INx	INx	INx	INx

Pins	Description	Minimum Voltage	
All Pins to Ground	Human Body Model	3 kV	

AC ELECTRICAL CHARACTERISTICS Typical: T = 25°C; V_{CC} = 3.3 V, R_L = 50 Ω , C_L = 5 pF, f = 1 MHz

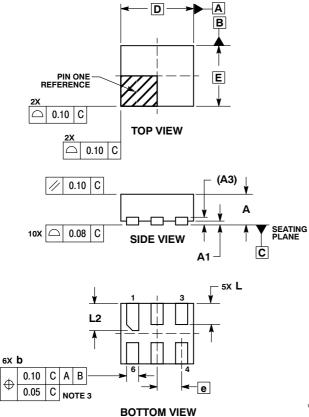
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
FREQUENCY		•					
BW	-3dB Bandwidth			457		MHz	
THD	Total Harmonic Distortion	f = 20 Hz to 20 kHz, 1.0 V _{PP}		0.08		%	
TRANSITION TIMES							
t _{ON}	Turn On Time: COM to NO			7.0		ns	
toff	Turn Off Time: COM to NO			4.5		ns	
OFF ISOLATION V_{NO}	OFF ISOLATION V_{NO} or V_{NC} (pk-pk) = 1.0 V						
O _{IRR}	Off Isolation			-57		dB	

CAPACITANCE

Symbol	Pins	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{IN}	INx	Control Input	V _{CC} = 0 V		2.8		pF
C _{ON}	NO to COM	Through Switch	$V_{CC} = V_{IN} = 3.3 \text{ V}$		20		pF
C _{OFF}	NO1, NO	Individual Port	$V_{CC} = 3.3 \text{ V}, V_{IN} = 0 \text{ V}$		14		pF

PACKAGE DIMENSIONS

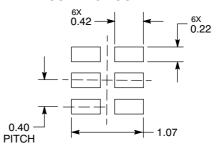
UDFN6, 1.2x1.0, 0.4P CASE 517AA-01 ISSUE B



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 mm FROM TERMINAL.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIM	MILLIMETERS				
DIM	MIN MAX					
Α	0.45 0.55					
A1	0.00 0.05					
А3	0.127 REF					
b	0.15 0.25					
D	1.20	BSC				
E	1.00	BSC				
е	0.40	BSC				
Ĺ	0.30	0.40				
L2	0.40	0.50				

MOUNTING FOOTPRINT*



DIMENSIONS: MILLIMETERS

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02

ISSUE W

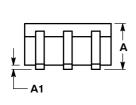
NOTES:

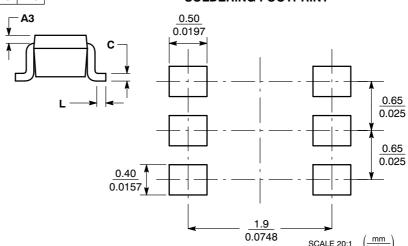
- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- 3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	MIL	LIMETE	ERS		INCHES	3	
DIM	MIN	NOM	MAX	MIN	MIN NOM		
Α	0.80	0.95	1.10	0.031	0.037	0.043	
A1	0.00	0.05	0.10	0.000	0.000 0.002		
А3		0.20 REF			0.008 RI	ΞF	
b	0.10	0.21	0.30	0.004	0.008	0.012	
С	0.10	0.14	0.25	0.004	0.005	0.010	
D	1.80	2.00	2.20	0.070	0.078	0.086	
E	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.012		
HF	2.00	2.10	2.20	0.078	0.082	0.086	

H_{E} **b** 6 PL ⊕ 0.2 (0.008) M E M

SOLDERING FOOTPRINT*





SC-88/SC70-6/SOT-363

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice on semiconductor and are registered raderians of semiconductor Components industries, Ite (SciLLC) solicit eserves the right to make changes without further holice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA **Phone**: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative